Di Duan

■ duandiacademic@gmail.com | Personal Homepage | Google Scholar | InkedIn

Research Interests: Wearable Sensing | Computational Health | Affective Computing Mobile System \times Human-Computer Interaction

Special Focus: System-enabled Novel Applications for Tracking, Reconstruction, Interaction, and Healthcare

Research Vision: Advancing the next generation of human-machine-environment interaction through ubiquitous mobile systems—making it more innovative, accessible, and affordable.

Positions

The Chinese University of Hong Kong (CUHK)

Postdoctoral Fellow (Full-Time) in the Department of Information Engineering

Advisor: Prof. Guoliang Xing.

Centre for Perceptual and Interactive Intelligence (CPII)

Postdoctoral Fellow

Mentor: Prof. Guoliang Xing.

Nov. 2024 - Apr. 2025

Aug. 2024 – Present

Hong Kong

Hong Kong

Education

City University of Hong Kong (CityU)

Ph.D. in Computer Science

Aug. 2020 – Jul. 2024 *Hong Kong*

Supervised by Prof. Weitao Xu, co-supervised by Prof. Xiaohua Jia. I also work closely with Dr. Tianxing Li at MSU.

Hong Kong University of Science and Technology (HKUST)

M.Sc. in Electronic Engineering

Aug. 2018 - Nov. 2019

Hong Kong

Harbin Engineering University (HEU)

B.Eng. in Optoelectronic Information Science and Engineering

Aug. 2014 – Aug. 2018 Harbin, Heilongjiang, China

Selected Awards

Best Paper Honorable Mention Award

T Honorable Mention Award

TMark Weiser Best Paper Award

P Best Demo Runner-up Award

Elsevier Monetary Award

* Studentship

SenSys'25, 2025

MobileHCI'24, 2024

PerCom'23, 2023

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SenSys'24, 2024

Elsevier, 2023

CityU, 2020

Publications

[SenSys'25] Argus: Multi-View Egocentric Human Mesh Reconstruction Based on Stripped-Down Wearable mmWave Add-on

Di Duan*, Shengzhe Lyu*, Mu Yuan, Hongfei Xue, Tianxing Li, Weitao Xu, Kaishun Wu, Guoliang Xing

T Best Paper Honorable Mention Award (5/235), 2025

[MobiSys'24] F²Key: Dynamically Converting Your Face into a Private Key Based on COTS Headphones for Reliable Voice Interaction

Di Duan, Zehua Sun, Tao Ni, Shuaicheng Li, Xiaohua Jia, Weitao Xu, Tianxing Li

2024

[IMWUT/UbiComp'24] EarSE: Bringing Robust Speech Enhancement to COTS Headphones

Di Duan, Yongliang Chen, Weitao Xu, Tianxing Li

2024

[PerCom'23] EMGSense: A Low-Effort Self-Supervised Domain Adaptation Framework for EMG Sensing

Di Duan, Huanqi Yang, Guohao Lan, Tianxing Li, Xiaohua Jia, Weitao Xu

P Best Paper Award (1/159), 2023

[MobileHCI'24] Medusa3D: The Watchful Eye Freezing Illegitimate Users in Virtual Reality Interactions Aochen Jiao*, **Di Duan*** (*co-first authors), Weitao Xu **The Honorable Mention Award (3/141)**, 2024 [SIGCOMM'25] SCX: Stateless KV-Cache Encoding for Cloud-Scale Confidential Transformer Serving Mu Yuan, Lan Zhang, Liekang Zeng, Siyang Jiang, Bufang Yang, **Di Duan**, Guoliang Xing 2025 [INFOCOM'25] iRadar: Synthesizing Millimeter-Waves from Wearable Inertial Inputs for Human Gesture Sensing Huangi Yang, Mingda Han, Xinyue Li, **Di Duan**, Tianxing Li, Weitao Xu 2025 [MobiCom'24] RF-Egg: An RF Solution for Fine-Grained Multi-Target and Multi-Task Egg Incubation Sensing Zehua Sun, Tao Ni, Yongliang Chen, **Di Duan**, Kai Liu, Weitao Xu 2024 [TMC] Scenario-Adaptive Key Establishment Scheme for LoRa-enabled IoV Communications Huanqi Yang, **Di Duan**, Hongbo Liu, Chengwen Luo, Yuezhong Wu, Wei Li, Albert Y. Zomaya, Linqi Song, Weitao Xu 2024 [TOSN] mmSign: mmWave-based Few-Shot Online Handwritten Signature Verification Mingda Han, Huanqi Yang, Tao Ni, **Di Duan**, Mengzhe Ruan, Yongliang Chen, Jia Zhang, Weitao Xu 2023 [CSCAIoTSys] EarDA: Towards Accurate and Data-Efficient Earable Activity Sensing Shengzhe Lyu, Yongliang Chen, **Di Duan**, Renqi Jia, Weitao Xu 2024 [SenSys'24 Demo] Myotrainer: Muscle-Aware Motion Analysis and Feedback System for In-Home Resistance Training Yuting He, Xinyan Wang, Mu Yuan, Di Duan, Doris S. F. Yu, Guoliang Xing, Hongkai Chen **Y** Best Demo Runner-up Award, 2024 **Professional Services Organizing Committee:** 2024: Publicity Chair of BodySys Workshop (MobiSys) **Technical Program Committee:** 2025: SenSys (Demo) 2024: ICPADS, CHCHI (Chinese CHI) **Artifact Evaluation Committee:** 2025: **MobiCom** 2024: **MobiSys Conference Review:** 2025: MobiCom, CHI, UbiComp, SIGCOMM IPSN, IOTDI, ICDCS, DCOSS-IoT, SenSys 2024: 2023: **IPSN** Journal Review: 2025: IMWUT, TMC (IEEE Trans), HEALTH (ACM Trans), TIOT (ACM Trans)

TMC (IEEE Trans), HEALTH (ACM Trans), Ad Hoc Networks 2024:

Reference

Guoliang Xing (Postdoc Advisor) ACM Fellow, IEEE Fellow, HKIE Fellow

Professor The Chinese University of Hong Kong

Email: glxing@ie.cuhk.edu.hk

Xiaohua Jia (Ph.D. Co-advisor) IEEE Fellow, ACM Distinguished Member

Chair Professor, Former Head of Department of Computer Science City University of Hong Kong Email: csjia@cityu.edu.hk

Weitao Xu (Ph.D. Advisor)

Associate Professor

Email: weitaoxu@cityu.edu.hk

<u>**Tianxing Li**</u> (Close Collaborator)

Assistant Professor

Email: litianx2@msu.edu

IEEE Senior Member

City University of Hong Kong

Michigan State University